

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10783562			
<b>Filing Date:</b>	19-Feb-2004			
<b>Title of Invention:</b>	METHOD AND SYSTEM FOR NUMERICALLY SIMULATING FOAM-LIKE MATERIAL IN FINITE ELEMENT ANALYSIS			
First Named Inventor/Applicant Name:	William W. Feng			
<b>Filer:</b>	Roger H. Chu			
<b>Attorney Docket Number:</b>	LSTC-004			
Filed as Small Entity				
<b>Utility      Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	2501	1	720	720
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				720